



PCB LOGO PCB LOGO Logo1 Logo2 Label Table Variant Label Text 001 ChangeMe! 002 ChangeMe! ZZ1

Label Assembly Note

This Assembly Note is for PCB labels only Z72
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed. ZZ3

ASSembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable. ZZ4

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified. Orderable: NA Designed for Public Release Mod. Date: 11/27/2017
TID #: TIDA-01588 Project Title: 10.8-V/15-W. Power Stage for Brushed DC Servo
Number: TIDA-01588 Rev: E2 Sheet Title:

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